### N and P-Channel Enhancement Mode Power MOSFET

### **Description**

The NCE603S uses advanced trench technology to provide excellent  $R_{DS(ON)}$  and low gate charge . The complementary MOSFETs may be used to form a level shifted high side switch, and for a host of other applications.

#### **General Features**

#### N-Channel

 $V_{DS} = 60V, I_{D} = 6.3A$ 

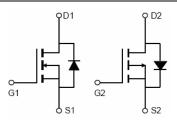
 $R_{DS(ON)} < 30 m\Omega$  @  $V_{GS}$ =10V

#### P-Channel

 $V_{DS} = -60V, I_{D} = -6A$ 

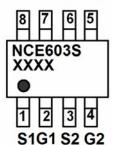
 $R_{DS(ON)}$  < 80m $\Omega$  @  $V_{GS}$ =-10V

- High power and current handing capability
- Lead free product is acquired
- Surface mount package



#### Schematic diagram

D1 D1 D2 D2



Marking and pin assignment



SOP-8 top view

### **Package Marking and Ordering Information**

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
NCE603S	NCE603S	SOP-8	Ø330mm	12mm	2500 units

Absolute Maximum Ratings (T<sub>A</sub>=25 ℃unless otherwise noted)

Param	Symbol	N-Channel	P-Channel	Unit		
Drain-Source Voltage		V <sub>DS</sub>	60	-60	V	
Gate-Source Voltage		$V_{GS}$	±20	±20	V	
Oraștia de Paris Orașta	T <sub>A</sub> =25℃		6.3		^	
Continuous Drain Current	T <sub>A</sub> =100°C	I <sub>D</sub>	4.5	-4.2	Α	
Pulsed Drain Current (Note 1)		I <sub>DM</sub>	40	-25	Α	
Maximum Power Dissipation T <sub>A</sub> =25 ℃		P <sub>D</sub>	2.0	2.0	W	
Operating Junction and Storage Temperature Range		$T_{J}$ , $T_{STG}$	-55 To 150	-55 To 150	$^{\circ}\!\mathbb{C}$	

### **Thermal Characteristic**

Thermal Resistance, Junction-to-Ambient (Note2)	$R_{\theta JA}$	N-Ch	62.5	°C/W
Thermal Resistance, Junction-to-Ambient (Note2)	$R_{\theta JA}$	P-Ch	62.5	°C/W



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# NCE603S

# N-CH Electrical Characteristics ( $T_A$ =25 $^{\circ}$ C unless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit
Off Characteristics						
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	BV <sub>DSS</sub> V <sub>GS</sub> =0V I <sub>D</sub> =250μA		-	-	V
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> =60V,V <sub>GS</sub> =0V	-	-	1	μA
Gate-Body Leakage Current	I <sub>GSS</sub>	V <sub>GS</sub> =±20V,V <sub>DS</sub> =0V	-	-	±100	nA
On Characteristics (Note 3)						
Gate Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS}=V_{GS},I_{D}=250\mu A$	1.2	1.6	2.5	V
Drain-Source On-State Resistance	R <sub>DS(ON)</sub>	V <sub>GS</sub> =10V, I <sub>D</sub> =6A	-	26	30	mΩ
Forward Transconductance	<b>g</b> FS	$V_{DS}$ =5 $V$ , $I_{D}$ =6 $A$	15	-	-	S
Dynamic Characteristics (Note4)						
Input Capacitance	C <sub>lss</sub>	\/ 45\/\/ 0\/	-	500	-	PF
Output Capacitance	Coss	$V_{DS}$ =15V, $V_{GS}$ =0V, F=1.0MHz	-	60	-	PF
Reverse Transfer Capacitance	C <sub>rss</sub>	F=1.UIVITIZ	-	25	-	PF
Switching Characteristics (Note 4)						
Turn-on Delay Time	t <sub>d(on)</sub>		-	5	-	nS
Turn-on Rise Time	t <sub>r</sub>	$V_{DD}$ =30V, $R_L$ =4.7 $\Omega$	-	2.6	-	nS
Turn-Off Delay Time	t <sub>d(off)</sub>	$V_{GS}$ =10 $V$ , $R_{GEN}$ =3 $\Omega$	-	16.1	-	nS
Turn-Off Fall Time	t <sub>f</sub>		-	2.3	-	nS
Total Gate Charge	Qg	\/ -45\/  -6A	-	25	-	nC
Gate-Source Charge	Q <sub>gs</sub>	$V_{DS}=15V, I_{D}=6A,$	-	4.5	-	nC
Gate-Drain Charge	$Q_{gd}$	V <sub>GS</sub> =10V	-	6.5	-	nC
Drain-Source Diode Characteristics			•	•		
Diode Forward Voltage (Note 3)	V <sub>SD</sub>	V <sub>GS</sub> =0V,I <sub>S</sub> =6A	-	0.8	1.2	V

# NCE603S

## P-CH Electrical Characteristics (T<sub>A</sub>=25 °C unless otherwise noted)

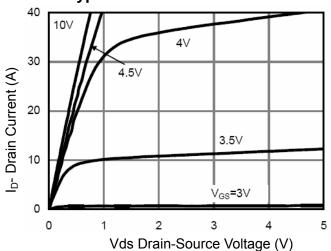
Parameter	Symbol	Condition	Min	Тур	Max	Unit	
Off Characteristics							
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	V <sub>GS</sub> =0V I <sub>D</sub> =-250μA	-60	-	-	V	
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> =-60V,V <sub>GS</sub> =0V	-	-	1	μA	
Gate-Body Leakage Current	I <sub>GSS</sub>	V <sub>GS</sub> =±20V,V <sub>DS</sub> =0V	-	-	±100	nA	
On Characteristics (Note 3)							
Gate Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS}$ = $V_{GS}$ , $I_{D}$ =-250 $\mu$ A	-1.5	-2.6	-3.5	V	
Drain-Source On-State Resistance	R <sub>DS(ON)</sub>	$V_{GS}$ =-10V, $I_D$ =-5A	-	64	80	mΩ	
Forward Transconductance	<b>G</b> FS	V <sub>DS</sub> =-15V,I <sub>D</sub> =-5A	16	-	-	S	
Dynamic Characteristics (Note4)							
Input Capacitance	C <sub>lss</sub>	\/ - 20\/\/ -0\/	-	1450	-	PF	
Output Capacitance	Coss	$V_{DS}$ =-20V, $V_{GS}$ =0V, F=1.0MHz	-	145	-	PF	
Reverse Transfer Capacitance	C <sub>rss</sub>	r-1.0Winz	-	110	-	PF	
Switching Characteristics (Note 4)							
Turn-on Delay Time	t <sub>d(on)</sub>		-	8	-	nS	
Turn-on Rise Time	t <sub>r</sub>	$V_{DD}$ =-30 $V$ , , $R_L$ =30 $\Omega$	-	9	-	nS	
Turn-Off Delay Time	$t_{d(off)}$	$V_{GS}$ =-10 $V$ , $R_{GEN}$ =6 $\Omega$	-	65	-	nS	
Turn-Off Fall Time	t <sub>f</sub>		-	30	-	nS	
Total Gate Charge	$Q_g$	V - 20VI - FA	-	26	-	nC	
Gate-Source Charge	Q <sub>gs</sub>	$V_{DS}$ =-30V, $I_{D}$ =-5A, $V_{GS}$ =-10V	-	4.5	-	nC	
Gate-Drain Charge	$Q_{gd}$	v <sub>GS</sub> 10v	-	7	-	nC	
Drain-Source Diode Characteristics	•						
Diode Forward Voltage (Note 3)	V <sub>SD</sub>	V <sub>GS</sub> =0V,I <sub>S</sub> =-6A	-	-	-1.2	V	
Diode Forward Current (Note 2)	Is		-	-	-6	Α	

### Notes:

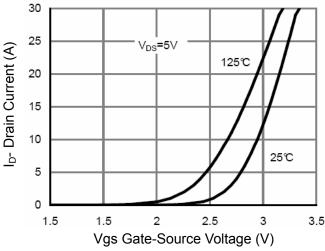
- $\textbf{1.} \ \textbf{Repetitive Rating: Pulse width limited by maximum junction temperature.}$
- 2. Surface Mounted on FR4 Board, t ≤ 10 sec.
- 3. Pulse Test: Pulse Width  $\leq$  300 $\mu$ s, Duty Cycle  $\leq$  2%.
- 4. Guaranteed by design, not subject to production



### N-CHTypical Electrical and Thermal Characteristics (Curves)



**Figure 1 Output Characteristics** 



**Figure 2 Transfer Characteristics** 

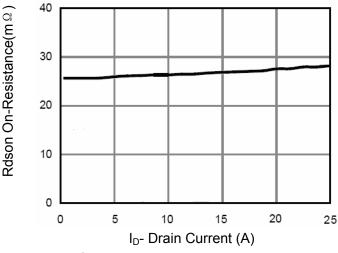
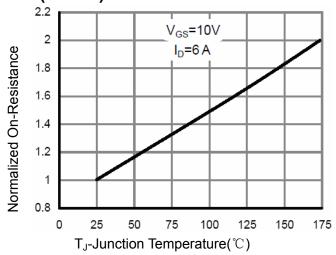


Figure 3 Rdson- Drain Current



**Figure 4 Rdson-Junction Temperature** 

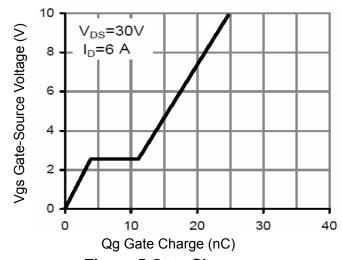


Figure 5 Gate Charge

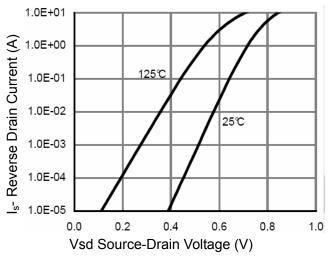


Figure 6 Source- Drain Diode Forward



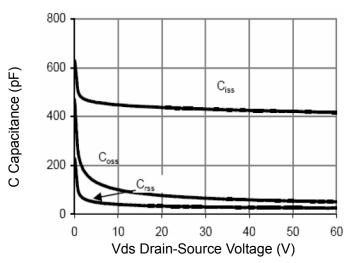


Figure 7 Capacitance vs Vds

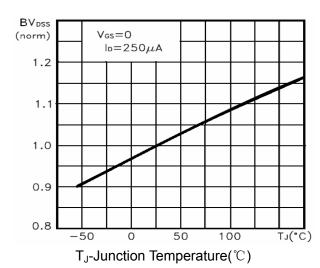
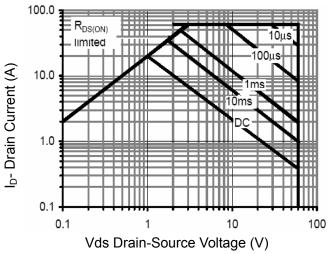


Figure 9 BV<sub>DSS</sub> vs Junction Temperature



**Figure 8 Safe Operation Area** 

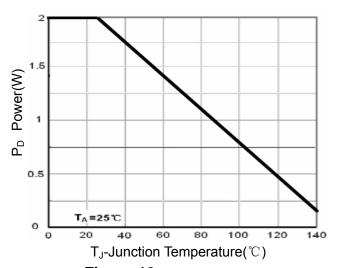


Figure 10 Power Dissipatio

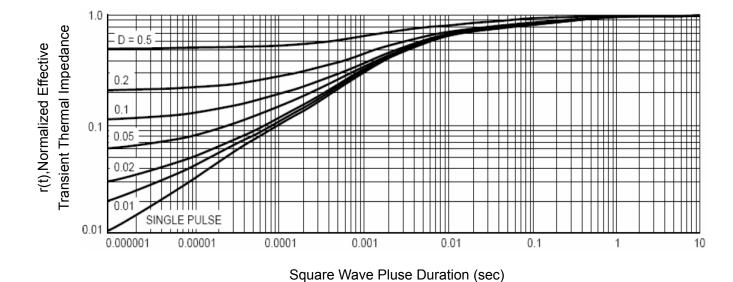


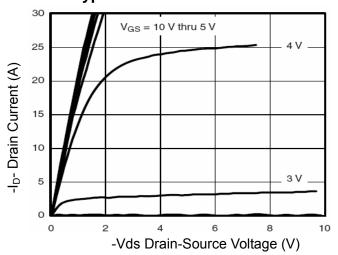
Figure 11 Normalized Maximum Transient Thermal Impedance

**Pb Free Product** 

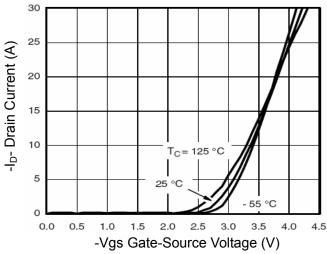


# P-CH Typical Electrical and Thermal Characteristics (Curves)

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**Figure 1 Output Characteristics** 



**Figure 2 Transfer Characteristics** 

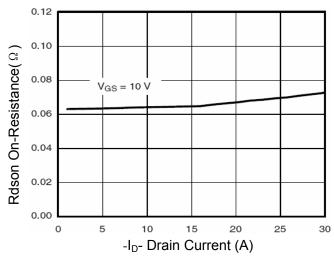
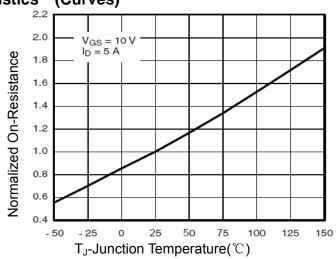


Figure 3 Rdson- Drain Current



**Figure 4 Rdson-Junction Temperature** 

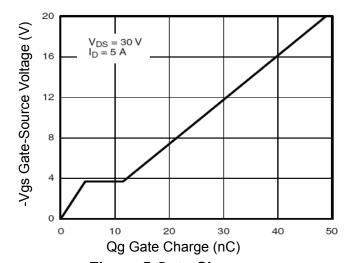


Figure 5 Gate Charge

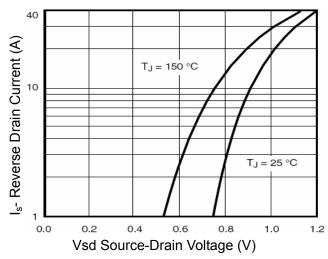
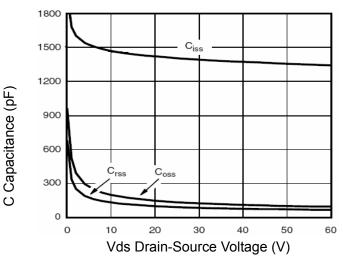
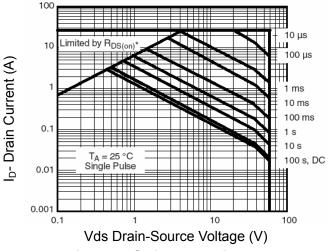


Figure 6 Source- Drain Diode Forward



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Figure 7 Capacitance vs Vds



**Figure 8 Safe Operation Area** 

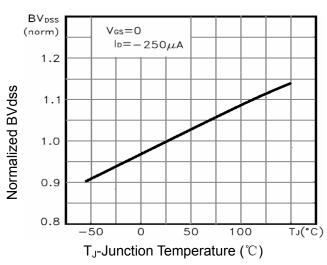


Figure 9 BV<sub>DSS</sub> vs Junction Temperature

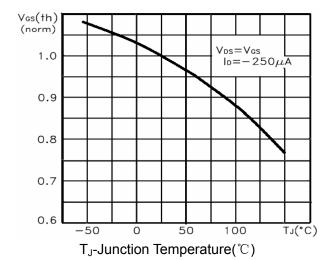


Figure 10 V<sub>GS(th)</sub> vs Junction Temperature

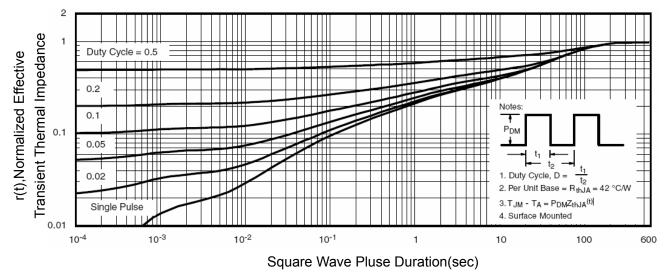
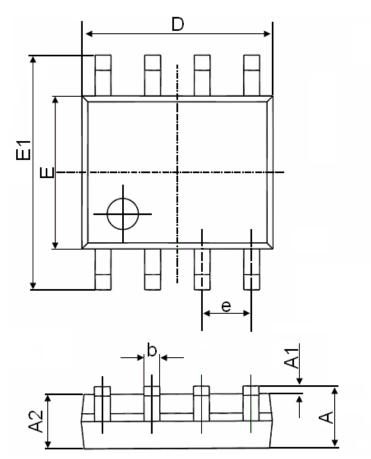


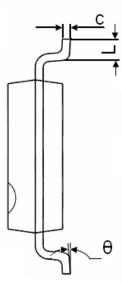
Figure 11 Normalized Maximum Transient Thermal Impedance

**Pb Free Product** 



# **SOP-8 Package Information**





Symbol	Dimensions I	n Millimeters	Dimensions In Inches		
	Min.	Max.	Min.	Max.	
А	1.350	1.750	0.053	0.069	
A1	0.100	0.250	0.004	0.010	
A2	1.350	1.550	0.053	0.061	
b	0.330	0.510	0.013	0.020	
С	0.170	0.250	0.006	0.010	
D	4.700	5.100	0.185	0.200	
E	3.800	4.000	0.150	0.157	
E1	5.800	6.200	0.228	0.244	
е	1.270	(BSC)	0.050(BSC)		
L	0.400	1.270	0.016	0.050	
θ	0°	8°	0°	8°	



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NCE603S

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